Thick-Film Hybrid IC

Inverter Power H-IC for 3-phase Motor Drive



http://onsemi.com

Overview

This "Inverter Power H-IC" is highly integrated device containing all High Voltage (HV) control from HV-DC to 3-phase outputs in a single SIP module (Single-In line Package). Output stage uses IGBT/FRD technology and implements Under Voltage Protection (UVP) and Over Current Protection (OCP) with a Fault Detection output flag. Internal Boost diodes are provided for high side gate boost drive.

Function

- Single control power supply due to Internal bootstrap circuit for high side pre-driver circuit
- All control input and status output are at low voltage levels directly compatible with microcontrollers
- Built-in dead time for shoot-thru protection
- Externally accessible embedded thermistor for substrate temperature measurement
- The level of the over-current protection current is adjustable with the external resistor, "RSD"

Certification

• UL1557 (File Number: E339285).

Specifications

Absolute Maximum Ratings at Tc = 25°C

Parameter	Symbol	Conditions		Ratings	Unit
Supply voltage	VCC	V+ to V-, surge < 500V	*1	450	V
Collector-emitter voltage	VCE	V+ to U,V,W or U,V,W to V-		600	٧
Outrot surrent	la.	V+, V-, U,V,W terminal current		±15	Α
Output current	lo	V+, V-, U,V,W terminal current at Tc = 100°C		±8	Α
Output peak current	lop	V+, V-, U,V,W terminal current for a Pulse width of 1ms.		±30	Α
Pre-driver voltage	VD1,2,3,4	VB1 to U, VB2 to V, VB3 to W, VDD to VSS	*2	20	٧
Input signal voltage	VIN	HIN1, 2, 3, LIN1, 2, 3		-0.3 to VDD	V
FAULT terminal voltage	VFAULT	FAULT terminal		-0.3 to VDD	٧
Maximum power dissipation	Pd	IGBT per channel		35	W
Junction temperature	Tj	IGBT,FRD		150	°C
Storage temperature	Tstg			-40 to +125	°C
Operating case temperature	Тс	H-IC case temperature		-40 to +100	°C
Tightening torque		Case mounting screws	*3	1.0	Nm
Withstand voltage	Vis	50Hz sine wave AC 1 minute	*4	2000	VRMS

Reference voltage is "VSS" terminal voltage unless otherwise specified.

- *1: Surge voltage developed by the switching operation due to the wiring inductance between + and U-(V-, W-) terminal.
- *2: Terminal voltage: VD1=VB1-U, VD2=VB2-V, VD3=VB3-W, VD4=VDD-VSS
- *3: Flatness of the heat-sink should be 0.15mm and below.
- *4: Test conditions : AC2500V, 1 second.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ORDERING INFORMATION

See detailed ordering and shipping information on page 15 of this data sheet.

Electrical Characteristics at Tc = 25°C, VD1, VD2, VD3, VD4 = 15V

Deremeter	Symbol Conditions			Test		Ratings	Ratings	
Parameter	Symbol	Co	nations	circuit	min	typ	max	Unit
Power output section								
Collector-emitter cut-off current	ICE	VCE = 600V		Fig. 4	-	-	0.1	mA
Bootstrap diode reverse current	IR(BD)	VR(BD)		Fig.1	-	-	0.1	mA
		Io = 15A	Upper side		-	1.8	2.7	
Collector to emitter	\(\(\sigma\)	Tj = 25°C	Lower side *1	Fi. 0	-	2.2	3.1	
saturation voltage	VCE(SAT)	Io = 8A	Upper side	Fig.2	-	1.3	-	V
		Tj = 100°C	Lower side *1		-	1.7	-	
		Io = 15A	Upper side		-	1.9	2.5	
		Tj = 25°C	Lower side *1	Ī	-	2.3	2.9	
Diode forward voltage	VF	Io = 8A	Upper side	Fig.3	-	1.4	-	V
		Tj = 100°C	Lower side *1	j	-	1.8	-	
Junction to case	θj-c(T)	IGBT	•	1	-	-	3.5	
thermal resistance	θj-c(D)	FRD			-	-	5	°C/W
Control (Pre-driver) section		-			l .		l .	ı
		VD1, 2, 3 = 15V			-	0.08	0.4	
Pre-driver power dissipation	ID	VD4 = 15V		Fig.4	-	1.6	4	mA
High level Input voltage	Vin H				2.5	-	-	V
Low level Input voltage	Vin L	HIN1, HIN2, F			-	-	0.8	V
Input threshold voltage hysteresis*1	Vinth(hys)	LIN1, LIN2, LI	N3 to VSS		0.5	0.8	-	V
Logic 1 input leakage current	I _{IN+}	VIN = +3.3V			-	100	143	μА
Logic 0 input leakage current	I _{IN-}	VIN = 0V			-	-	2	μА
FAULT terminal input electric current	IoSD	FAULT : ON/\	/FAULT = 0.1V		-	2	-	mA
FAULT clear time	FLTCLR	Fault output la	atch time.		18	-	80	ms
V _{CC} and V _S undervoltage positive	V _{CCUV+}				10.5	11.1	11.7	V
going threshold.	V _{SUV+}							
V_{CC} and V_{S} undervoltage negative going threshold.	V _{CCUV} -				10.3	10.9	11.5	V
V_{CC} and V_{S} undervoltage hysteresis	V _{CCUVH} V _{SUVH-}				0.14	0.2	-	А
Over current protection level	ISD	PW = 100μs, RSD = 0Ω		Fig.5	22.0	-	27.8	Α
Output level for current monitor	ISO	lo = 15A			0.36	0.38	0.40	V
Thermistor for substrate temperature	Rt	Thermistor Re	esistance		90	100	110	kΩ

Reference voltage is "VSS" terminal voltage unless otherwise specified.

^{*1:} The lower side's VCE(SAT) and VF include a loss by the shunt resistance

D	0	O and Williams	Test		Ratings		11.2
Parameter	Symbol	Conditions	circuit	min	typ	max	Unit
Switching Character							
Constitution on time o	tON	Io = 15A		0.3	0.6	1.3	
Switching time	tOFF	Inductive load		1	1.0	1.8	μ\$
Turn-on switching loss	Eon	$Ic = 8A, V^{+} = 300V,$		-	170	-	μJ
Turn-off switching loss	Eoff	V _{DD} = 15V, L = 3.9mH	Fi. 0	-	210	-	μJ
Total switching loss	Etot	Tc = 25°C	Fig.6	1	380	1	μJ
Turn-on switching loss	Eon	Ic = 8A, V ⁺ = 300 V,		-	220	-	μJ
Turn-off switching loss	Eoff	V _{DD} = 15V, L = 3.9mH		-	380	-	μJ
Total switching loss	Etot	Tc = 100°C		ı	600	1	μJ
Diode reverse recovery energy	Erec	$I_F = 8A, V^{\dagger} = 400V, V_{DD} = 15V,$		-	12	-	μJ
Diode reverse recovery time	Trr	L = 3.9mH, Tc = 100°C		-	54	-	ns
Reverse bias safe operating area	RBSOA	Io = 30A, VCE = 450V			Full square		
Short circuit safe operating area	SCSOA	VCE = 400V, Tc = 100°C		4	-	-	μS
Allowable offset voltage slew rate	dv/dt	Between U,V,W to U-,V-,W-		-50	-	50	V/ns

Reference voltage is "VSS" terminal voltage unless otherwise specified.

Notes:

1. When the internal protection circuit operates, a Fault signal is turned ON (When the Fault terminal is low level, Fault signal is ON state: output form is open DRAIN) but the Fault signal does not latch. After protection operation ends, it returns automatically within about 18ms to 80ms and resumes operation beginning condition. So, after Fault signal detection, set all input signals to OFF (Low) at once. However, the operation of pre-drive power supply low voltage protection (UVLO: with hysteresis about 0.2V) is as follows.

Upper side:

The gate is turned off and will return to regular operation when recovering to the normal voltage, but the latch will continue till the input signal will turn 'low'.

Lower side:

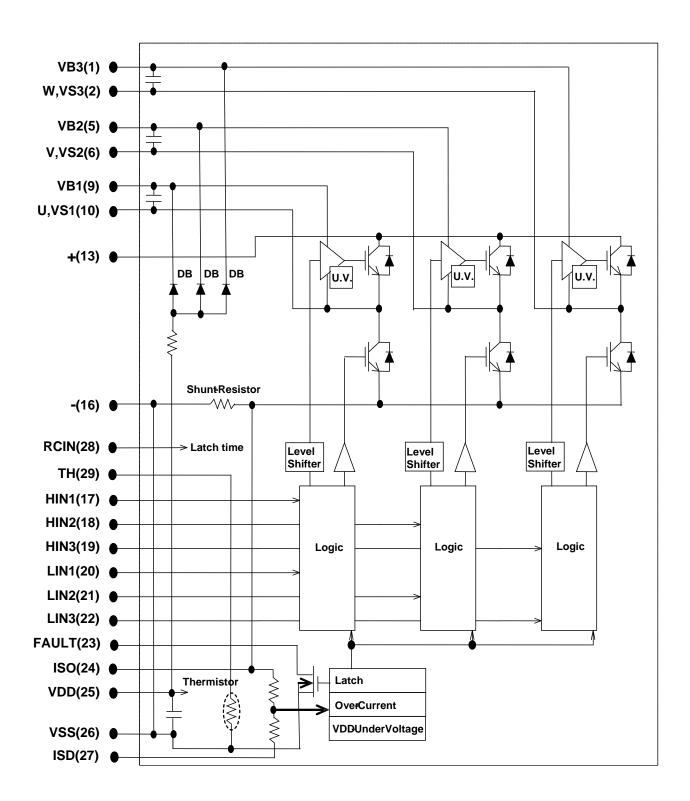
The gate is turned off and will automatically reset when recovering to normal voltage. It does not depend on input signal voltage.

- 2. When assembling the H-IC on the heat sink with M3 type screw, tightening torque range is 0.6 Nm to 0.9 Nm.
- 3. The pre-drive low voltage protection is the feature to protect devices when the pre-driver supply voltage falls due to an operating malfunction.

Module Pin-Out Description

Pin	Name	Description
1	VB3	High Side Floating Supply Voltage 3
2	W, VS3	Output 3 - High Side Floating Supply Offset Voltage
3	-	Without Pin
4	_	Without Pin
5	VB2	High Side Floating Supply voltage 2
6	V,VS2	Output 2 - High Side Floating Supply Offset Voltage
7	-	Without Pin
8	-	Without Pin
9	VB1	High Side Floating Supply voltage 1
10	U,VS1	Output 1 - High Side Floating Supply Offset Voltage
11	-	Without Pin
12	-	none
13	V+	Positive Bus Input Voltage
14	NA	none
15	NA	none
16	V-	Negative Bus Input Voltage
17	HIN1	Logic Input High Side Gate Driver - Phase 1
18	HIN2	Logic Input High Side Gate Driver - Phase V
19	HIN3	Logic Input High Side Gate Driver - Phase W
20	LIN1	Logic Input Low Side Gate Driver - Phase U
21	LIN2	Logic Input Low Side Gate Driver - Phase V
22	LIN3	Logic Input Low Side Gate Driver - Phase W
23	FLTEN	Enable input / Fault output
24	ISO	Current monitor output
25	VDD	+15V Main Supply
26	vss	Negative Main Supply
27	ISD	Over current detection and setting
28	RCIN	Fault clear time setting output
29	тн	Thermistor output

Equivalent Block Diagram



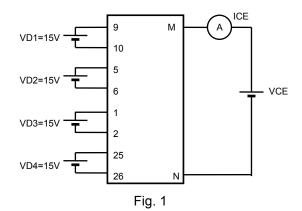
Test Circuit

(The tested phase : U+ shows the upper side of the U phase and U- shows the lower side of the U phase.)

■ ICE / IR(BD)

	U+	V+	W+	U-	V-	W-
М	13	13	13	10	6	2
N	10	6	2	16	16	16

	U(BD)	V(BD)	W(BD)
М	9	5	1
N	26	26	26



■ VCE(SAT) (Test by pulse)

	U+	V+	W+	U-	V-	W-
М	13	13	13	10	6	2
N	10	6	2	16	16	16
m	17	18	19	20	21	22

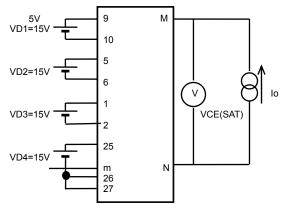
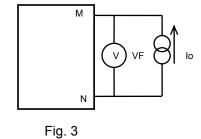


Fig. 2

■ VF (Test by pulse)

	U+	V+	W+	U-	V-	W-
М	13	13	13	10	6	2
N	10	6	2	16	16	16



■ ID

	VD1	VD2	VD3	VD4
М	9	5	1	25
N	10	6	2	26

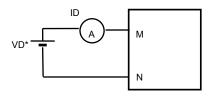
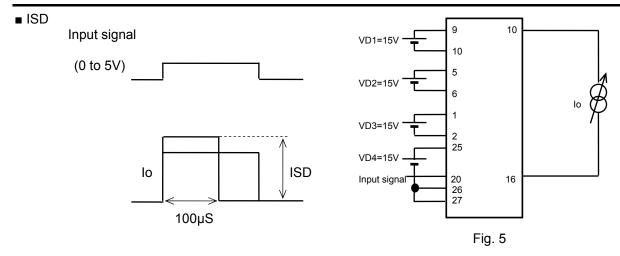
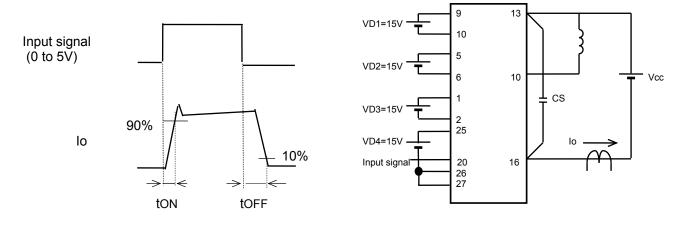


Fig. 4



■ Switching time (The circuit is a representative example of the lower side U phase.)



Logic Timing Chart

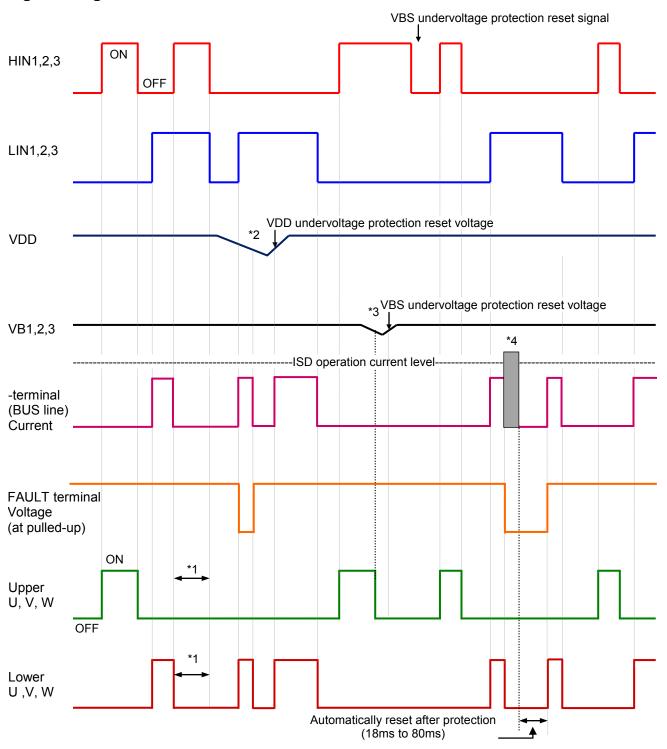
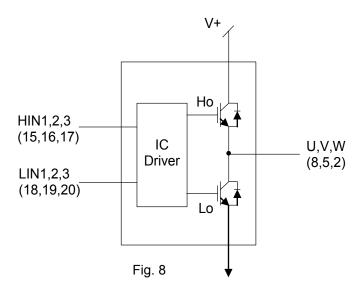


Fig. 7

Notes

- *1: Diagram shows the prevention of shoot-through via control logic. More dead time to account for switching delay needs to be added externally.
- *2: When VDD decreases all gate output signals will go low and cut off all of 6 IGBT outputs. part. When VDD rises the operation will resume immediately.
- *3: When the upper side gate voltage at VB1, VB2 and VB3 drops only, the corresponding upper side output is turned off. The outputs return to normal operation immediately after the upper side gat voltage rises.
- *4: In case of over current detection, all IGBT's are turned off and the FAULT output is asserted. Normal operation resumes in 18 to 80ms after the over current condition is removed.

Logic level table



FLTEN	Itrip	HIN1,2,3	LIN1,2,3	U,V,W
1	0	1	0	Vbus
1	0	0	1	0
1	0	0	0	Off
1	0	1	1	Off
1	1	Х	Х	Off
0	X	X	X	Off

Sample Application Circuit

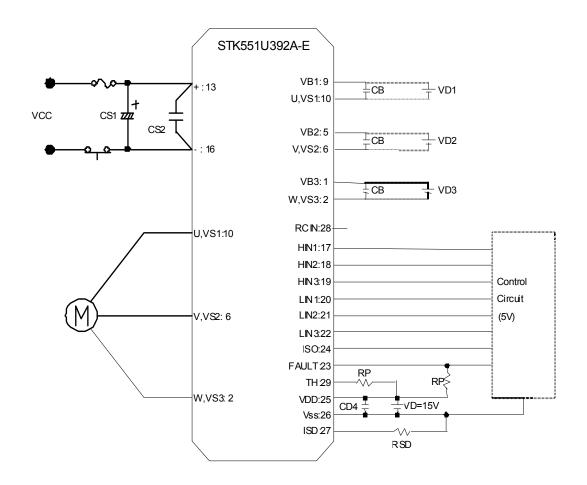


Fig. 9

Recommended Operating Conditions at Tc = 25°C

	0	Q I'll			Ratings		Unit
Item	Symbol	Conditions	Conditions		typ	max	Unit
Supply voltage	VCC	+ to U-(V-,W-)		0	280	450	V
Pre-driver	VD1,2,3	VB1 to U, VB2 to V, VB3 to W		12.5	15	17.5	
supply voltage	VD4	VDD to VSS	*1	13.5	15	16.5	V
ON-state input voltage	VIN(ON)	HIN1, HIN2, HIN3,		3.0	-	5.0	.,
OFF-state input voltage	VIN(OFF)	LIN1, LIN2, LIN3		0	-	0.3	V
PWM frequency	fPWM			1	-	20	kHz
Dead time	DT	Turn-off to turn-on		1.5	-	-	μS
Allowable input pulse width	PWIN	ON and OFF		1	-	-	μS
Tightening torque		'M3' type screw		0.6	-	0.9	Nm

^{*1} Pre-drive power supply (VD4=15±1.5V) must be have the capacity of Io=20mA(DC), 0.5A(Peak).

Usage Precautions

- 1. This H-IC includes bootstrap diode and resistors. Therefore, by adding a capacitor "CB", a high side drive voltage is generated; each phase requires an individual bootstrap capacitor. The recommended value of CB is in the range of 1 to $47\mu\text{F}$, however this value needs to be verified prior to production. If selecting the capacitance more than $47\mu\text{F}$ ($\pm20\%$), connect a resistor (about 20Ω) in series between each 3-phase upper side power supply terminals (VB1,2,3) and each bootstrap capacitor. When not using the bootstrap circuit, each upper side pre-drive power supply requires an external independent power supply.
- 2. It is essential that wirning length between terminals in the snubber circuit be kept as short as possible to reduce the effect of surge voltages. Recommended value of "CS" is in the range of 0.1 to $10\mu F$.
- 3. "ISO" (pin24) is terminal for current monitor. When the pull-down resistor is used, please select it more than $5.6k\Omega$
- "FAULT" (pin23) is open DRAIN output terminal. (Active Low). Pull up resistor is recommended more than 5.6kΩ.
- 5. Inside the H-IC, a thermistor used as the temperature monitor for internal subatrate is connected between VSS terminal and TH terminal, therefore, an external pull up resistor connected between the TH terminal and an external power supply should be used. The temperature monitor example application is as follows, please refer the Fig.10, and Fig.11 below.
- 6. pull down resistor of $33k\Omega$ is provided internally at the signal input terminals. An external resistor of 2.2k to $3.3k\Omega$ should be added to reduce the influence of external wiring noise.
- 7. The over-current protection feature is not intended to protect in exceptional fault condition. An external fuse is recommended for safety.
- 8. When "-" and "VSS" terminal are short-circuited on the outside, level that over-current protection (ISD) might be changed from designed value as H-IC. Please check it in your set ("N" terminal and "VSS" terminal are connected in H-IC).
- 9. The over-current protection function operates normally when an external resistor RSD is connected between ISD and VSS terminals. Be sure to connect this resistor. The level of the overcurrent protection can be changed according to the RSD value.
- 10. When input pulse width is less than 1.0µs, an output may not react to the pulse. (Both ON signal and OFF signal)

This data shows the example of the application circuit, does not guarantee a design as the mass production set.

The characteristic of thermistor is as follows.

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Resistance	R ₂₅	Tc = 25°C	97	100	103	kΩ
Resistance	R ₁₀₀	Tc = 100°C	4.93	5.38	5.88	kΩ
B-Constant (25 to 50 °C)	В		4165	4250	4335	k
Temperature Range			-40	1	+125	°C

■ This data shows the example of the application circuit, does not guarantee a design as the mass production set.

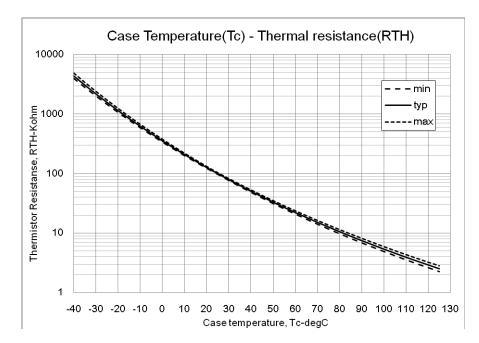


Fig. 10

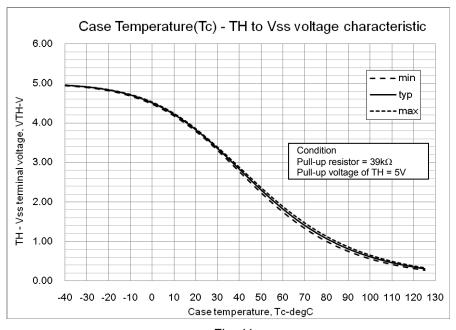


Fig. 11

The characteristic of PWM switching frequency

Maximum sinusoidal phase current as function of switching frequency (VBUS=400V, Tc=100°C)

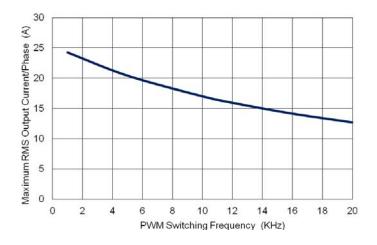


Fig.12

Switching waveform

IGBT Turn-on. Typical turn-on waveform @Tc=100deg, V_{BUS}=400V

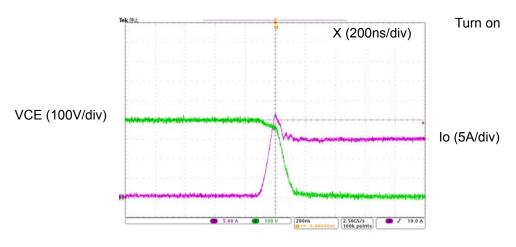


Fig. 13

IGBT Turn-off. Typical turn-off waveform @Tc=100deg, V_{BUS}=400V

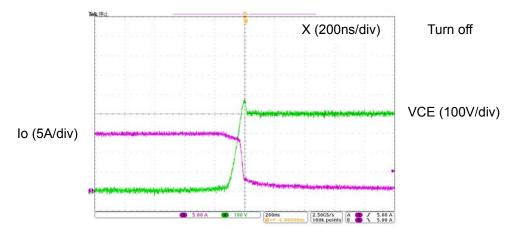


Fig. 14

CB capacitor value calculation for bootstrap circuit

Calculate condition

Item	Symbol	Value	Unit
Upper side power supply.	VBS	15	V
Total gate charge of output power IGBT at 15V.	Qg	132	nC
Upper side power supply low voltage protection.	UVLO	12	V
Upper side power dissipation.	IDmax	400	μΑ
ON time required for CB voltage to fall from 15V to UVLO	Ton-max	-	S

Capacitance calculation formula

CB must not be discharged below to the upper limit of the UVLO - the maximum allowable on-time (Ton-max) of the upper side is calculated as follows:

The relationship between Ton-max and CB becomes as follows. CB is recommended to be approximately 3 times the value calculated above. The recommended value of CB is in the range of 1 to 47μ F, however, the value needs to be verified prior to production.

Tonmax-Cb characteristic

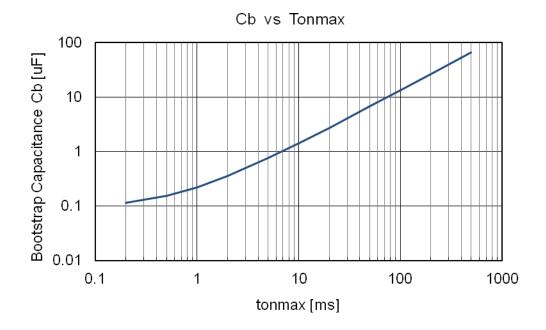
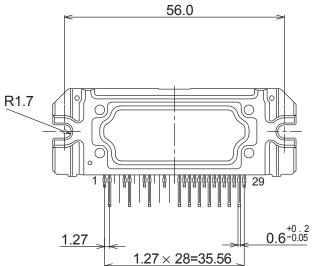
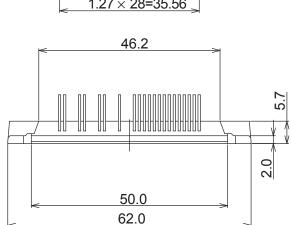


Fig 16

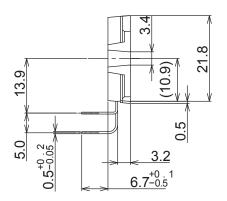
Package Dimensions

(unit : mm) SIP29 56x21.8 CASE 127BW ISSUE O





missing pin: 3,4,7,8,11,12,14,15



ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
STK551U392A-E	SIP29 56x21.8 (Pb-Free)	8 / Tube

ON Semiconductor and the ON logo are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equa